

Please replace the paragraph beginning at page 13, line 1 with the following rewritten paragraph:

Looking at the paste from a side, which has been applied as described above, from one side of the lead frame, the paste appears as shown in Fig. 4(A). In practice, a central portion of the applied paste is slightly higher than a peripheral portion of the applied paste due to the presence of the extra paste.

IN THE CLAIMS:

Please CANCEL claim 13 without prejudice or disclaimer.

Please AMEND the claims as follows:

1. (Amended) A method of applying a paste on a paste-applied body, comprising the steps of:
 - forming a two-dimensional paste pattern on a first joining surface of paste-applied body with a drawn paste line; and
 - placing on the paste pattern a second joining surface of a chip member to be bonded, wherein no bubbles are left in the first and second joining surfaces when the first and second joining surfaces are bonded to each other.

2. (Amended) A paste pattern forming method according to Claim 1, wherein said paste line is drawn by using a nozzle, the paste, a paste reserving container, and paste supply means.

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3. (Amended) A paste pattern forming method according to Claim 2, wherein said paste is continuously discharged from said nozzle while the paste line is being drawn.

6. (Amended) A paste pattern forming method according to claim 1 or 2, wherein said pattern is a figure made up of a plurality of segment lines.

7. (Amended) A paste pattern forming method according to Claim 6, wherein said pattern is a figure in a radial form.

8. (Amended) A paste pattern forming method according to claim 1 or 2, wherein said pattern is a figure including an enclosed shape.

10. (Amended) A paste pattern forming method according to Claim 9, wherein at least one segment line is formed while moving any of said paste-applied body, said nozzle and said paste traveling in two paths, of which a first path is in one direction and a second path is in the opposite direction tracing the first path.

11. (Amended) A paste pattern forming method according to claim 10, wherein said drawing pattern is formed such that starting point coincides with end point of drawing said line segment.

Please ADD the following new claim:

14. (New) A method of uniformly applying a paste, comprising the steps of:

forming a pattern of ^{or} paste line on a first surface of a paste-applied body; and

placing on the paste pattern a member with a second surface, thereby sandwiching the paste pattern

with the first surface and the second surface;

wherein the paste is spread all over between the first surface and the second surface leaving no
bubble in the paste.